

# Product data sheet

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Semiconductor Compiance

#### **FEATURES**

♦ IEC61000-4-2 (ESD) ±8kV (Contact)

±15kV (Air)

- ♦ IEC61000-4-5 (Lighting) 3A (8/20µs)
- ♦ 100 Watts Peak Pulse Power (tp=8/20µs)
- ♦ Working voltages : 24V
- ♦ Low clamping voltage
- ♦ Low leakage current

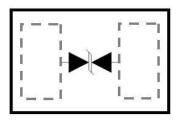
#### **MACHANICAL DATA**

- ♦ DFN1006 package
- ♦ Flammability Rating: UL 94V-0
- ♦ Packaging: Tape and Reel
- ♦ Reel size: 7 inch



DFN1006

#### **PIN CONFIGURATION**



#### APPLICATIONS

- Serial and Parallel Ports
- Notebooks, Desktops, Servers
- ♦ Projection TV
- Cellular handsets and accessories
- Portable instrumentation
- ♦ Peripherals

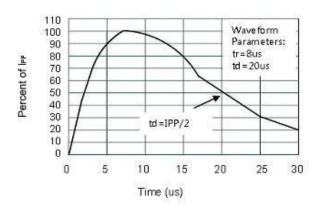
ABSOLUTE MAXIMUM RATING				
Symbol	Parameter	Value	Units	
V <sub>ESD</sub>	ESD per IEC 61000-4-2 (Contact)	±8	kV	
	ESD per IEC 61000-4-2 (Air)	±15	κv	
P <sub>PP</sub>	Peak Pulse Power (8/20µs)	150	W	
T <sub>OPT</sub>	Operating Temperature	-55 ~ +125	°C	
T <sub>STG</sub>	Storage Temperature	-55 ~ +150	°C	
TL	Lead Soldering Temperature	260 (10 sec.)	°C	

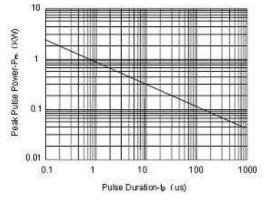


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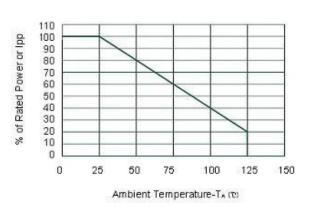
ELECTRICAL CHARACTERISTICS (Tamb=25°C)						
Symbol	Parameter	Test Condition	Min	Тур	Max	Units
V <sub>RWM</sub>	Reverse Working Voltage				24	V
V <sub>BR</sub>	Reverse Breakdown Voltage	I⊤ = 1mA	26		32	V
I <sub>R</sub>	Reverse Leakage Current	$V_{RWM} = 24V$			1	μA
V <sub>C1</sub>	Clamping Voltage 1	I <sub>PP</sub> = 1A, t <sub>p</sub> = 8/20µs			40	V
V <sub>C2</sub>	Clamping Voltage 2	$I_{PP} = 3A, t_p = 8/20 \mu s$			50	V
CJ	Junction Capacitance	$V_R = 0V$ , f = 1MHz		8		pF

#### ELECTRICAL CHARACTERISTICS CURVE









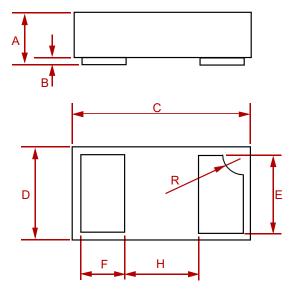
Non-Repetitive Peak Pulse Power vs. Pulse Time



D24V0L1B2LPS-7B HE 🐼

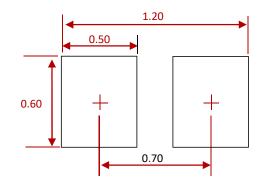
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#### PACKAGE MECHANICAL DATA



Dire	Inches		Millimeters		
Dim	MIN	MAX	MIN	МАХ	
A	0.0125	0.02	0.32	0.52	
В	0.000	0.002	0.00	0.05	
С	0.037	0.043	0.95	1.080	
D	0.022	0.027	0.55	0.680	
E	0.016	0.024	0.40	0.60	
F	0.008	0.012	0.20	0.30	
н	0.01	5Тур.	0.40	Тур.	
R	0.001	0.005	0.05	0.15	

### **Suggested Pad Layout**



NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

#### **REEL SPECIFICATION**

P/N	PKG	QTY
D24V0L1B2LPS-7B	DFN1006	10000





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